High Temperature 150°C, X8L Dielectric, 10 – 50 VDC (Commercial & Automotive Grade)



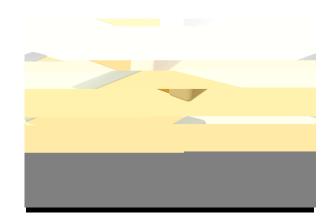
Overview

KEMET's X8L dielectric features a 150°C maximum operating temperature and is considered "general purpose high temperature." These components are fixed, ceramic dielectric capacitors suited for high temperature bypass and decoupling applications or frequency discriminating circuits where Q and stability of capacitance characteristics are not critical. X8L exhibits a predictable change in capacitance with respect to time and voltage and boasts a minimal change in capacitance with reference to ambient temperature up to 125°C. Beyond 125°C X8L displays a wider variation in capacitance. Capacitance change is limited to ±15% from -55°C to +125°C and +15, -40% from 125°C to 150°C.

Driven by the demand for a more robust and reliable component, X8L dielectric capacitors were developed for critical applications where reliability at higher operating temperatures are a concern. These capacitors are widely used in automotive circuits as well as general high temperature applications. Concerned with flex cracks resulting from excessive tensile and shear stresses produced during board flexure and thermal cycling?

These devices are available with KEMET's Flexible termination technology which inhibits the transfer of board stress to the rigid ceramic body, therefore mitigating flex cracks which can result in low IR or short circuit failures. Although flexible termination technology does not eliminate the potential for mechanical damage that may propagate during extreme environmental and handling conditions, it does provide superior flex performance over standard termination systems.

In addition to commercial grade, automotive grade devices are available and meet the demanding Automotive Electronics Council's AEC-Q200 qualification requirements.



Ordering Information

С	1210	X	106	K	8	N	Α	С	TU
Ceramic	Case Size (L" x W")	Specification/ Series ¹	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VDC)	Dielectric	Failure Rate/ Design	Termination FinishWMI*	

Additional termination fnish options may be available. Contact KEMET for details.

²SnPb termination fnish option is not available on Automotive Grade product.



Packaging C-Spec Ordering Options Table

Packaging Type	Packaging/Grade Ordering Code (C-Spec)
Commerc	ial Grade ¹
Bulk Bag	Not Required (Blank)
7" Reel/Unmarked	TU
13" Reel/Unmarked	7411 (EIA 0603 and smaller case sizes) 7210 (EIA 0805 and larger case sizes)
7" Reel/Marked	TM
13" Reel/Marked	7040 (EIA 0603 and smaller case sizes) 7215 (EIA 0805 and larger case sizes)
7" Reel/Unmarked/2 mm pitch ²	7081
13" Reel/Unmarked/2 mm pitch ²	7082
Automoti	ve Grade ³
7" Reel	AUTO
13" Reel/Unmarked	AUTO7411 (EIA 0603 and smaller case sizes) AUTO7210 (EIA 0805 and larger case sizes)
7" Reel/Unmarked/2 mm pitch ²	3190
13" Reel/Unmarked/2 mm pitch ²	3191

¹ Default packaging is "Bulk Bag". An ordering code C-Spec is not required for "Bulk Bag" packaging.

Benefits

•

¹ The terms "Marked" and "Unmarked" pertain to laser marking option of capacitors. All packaging options labeled as "Unmarked" will contain capacitors that have not been laser marked.

² The 2 mm pitch option allows for double the packaging quantity of capacitors on a given reel size. This option is limited to EIA 0603 (1608 metric) case size devices. For more information regarding 2 mm pitch option see "Tape & Reel Packaging Information".

³ Reeling tape options (Paper or Plastic) are dependent on capacitor case size (L" x W") and thickness dimension. See "Chip Thickness/Tape & Reel Packaging Quantities" and "Tape & Reel Packaging Information".

³ For additional Information regarding "AUTO" C-Spec options, see "Automotive C-Spec Information".

³ All Automotive packaging C-Specs listed exclude the option to laser mark components. Please contact KEMET if you require a laser marked option. For more information see "Capacitor Marking".



Automotive C-Spec Information

KEMET Automotive Grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. These products are supported by a Product Change Notification (PCN) and Production Part Approval Process warrant (PPAP).

Automotive products offered through our distribution channel have been assigned an inclusive ordering code C-Spec, "AUTO." This C-Spec was developed in order to better serve small and medium-sized companies that prefer an automotive grade component without the requirement to submit a customer Source Controlled Drawing (SCD) or specification for review by a KEMET engineering specialist. This C-Spec is therefore not intended for use by KEMET's OEM Automotive customers and are not granted the same "privileges" as other automotive C-Specs. Customer PCN approval and PPAP request levels are limited (see details below).

Product Change Notification (PCN)

The KEMET Product Change Notification system is used to communicate primarily the following types of changes:

- Product/process changes that affect product form, fit, function, and/or reliability
- · Changes in manufacturing site
- Product obsolescence

KEMET Automotive	Customer Notifica	tion due to:	Days prior to
C-Spec	Process/Product change	Obsolescence*	implementation
KEMET assigned ¹	Yes (with approval and sign off)	Yes	180 days minimum
AUTO	Yes (without approval)	Yes	90 days minimum

¹ KEMET assigned C-Specs require the submittal of a customer SCD or customer specification for review. For additional information contact KEMET.

Production Part Approval Process (PPAP)

The purpose of the Production Part Approval Process is:

- To ensure that supplier can meet the manufacturability and quality requirements for the purchased parts.
- To provide the evidence that all customer engineering design record and specification requirements are properly understood and fulfilled by the manufacturing organization.
- To demonstrate that the established manufacturing process has the potential to produce the part.

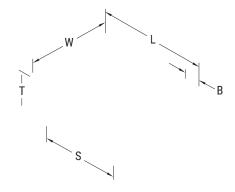
KEMET Automotive		PPAP (Product	Part Approval	Process) Leve	I
C-Spec	1	2	3	4	5
KEMET assigned ¹	•	•	•	•	•
AUTO	0		0		

¹ KEMET assigned C-Specs require the submittal of a customer SCD or customer specification for review. For additional information contact KEMET.

- Part number specific PPAP available
- Product family PPAP only



Dimensions – Standard Termination – Millimeters (Inches)





Qualification/Certification

Commercial Grade products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 4, Performance & Reliability.

Automotive Grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. For additional information regarding the Automotive Electronics Council and AEC-Q200, please visit their website at www.aecouncil.com.

Environmental Compliance

Lead (Pb)-free, RoHS, and REACH compliant without exemptions (excluding SnPb termination finish option).

Electrical Parameters/Characteristics

Item	Parameters/Characteristics
Operating Temperature Range	-55°C to +150°C
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	±15% (-55°C to 125°C), +15, -40% (125°C to 150°C)
¹ Aging Rate (Maximum % Capacitance Loss/Decade Hour)	3.0%
² Dielectric Withstanding Voltage (DWV)	250% of rated voltage (5±1 seconds and charge/discharge not exceeding 50 mA)
³ Dissipation Factor (DF) Maximum Limit at 25°C	3.5% (≤ 16V) and 2.5% (≥ 25V)
⁴ Insulation Resistance (IR) Minimum Limit at 25°C	500 megohm microfarads or 10 GΩ (Rated voltage applied for 120±5 seconds at 25°C)

Regarding Aging Rate: Capacitance measurements (including tolerance) are indexed to a referee time of 1,000 hours.

2



Table 1 – Capacitance Range/Selection Waterfall (0402 – 1210 Case Sizes)

	Сар		se Si Serie:			C04	020			C	0603	3C			C	080!	5C			C.	1206	5C			C.	1210	С	
Cap	Code	Vo	ltage Co	ode	9	8	4	3	9	8	4	3	5	9	8	4	3	5	9	8	4	3	5	9	8	4	3	5
		Rated	Voltage	(VDC)	6.3	10	16	25	6.3	10	16	25	50	6.3	10	16	25	50	6.3	10	16	25	50	6.3	10	16	25	50
		Capaci	tance To	lerance				Prod	uct A	vailal	oility	and (Chip	Thick	ness	Code	es Se	e Tab	le 2 f	or Ch	ip Th	ickn	ess D	imen	sions	;		
12,000 pF	123	J	K	М	BB	BB	BB	BB																				
15,000 pF	153	J	K	M	BB	BB	BB	BB																				
18,000 pF	183	J	K	M	BB	BB	BB	BB																				
22,000 pF	223	J	K	M	BB	BB	BB	BB																				
27,000 pF	273	J	K	M	BB	BB	BB																					
33,000 pF	333	J	K	M	BB	BB	BB							•														
39,000 pF	393	J	K	M	BB	BB	BB		٥٦	٥٦	0.5	٥٦	0.5															
47,000 pF	473	J	K	M	BB	BB	BB		CF	CF	CF	CF	CF															
56,000 pF	563	J	K	M	BB	BB BB																						
68,000 pF	683 823	J	K	M	BB BB	BB																						
82,000 pF 0.10 μF	104	J	K	M	BB	BB			CF	CF	CF	CF																
0.10 μF 0.12 μF	104	J	K	M	DD	DD			CF	CF	CF	CF																
0.12 μΓ 0.15 μF	154	J	K	M					CF	CF	CF	CF		DG	DG	DG	DG	DG										
0.13 μF	184	J	K	M					CF	CF	CF	CI		DG	DG	DG	DG	DG										
0.10 μF	224	J	K	M					CF	CF	CF			DP	DP	DP	DP	DG										
0.22 µr 0.27 µF	274	J	K	M	i				01	01	O1			DP	DP	DP	DP	00										
0.27 µF	334	J	K	M	i									DP	DP	DP	DP											
0.39 µF	394	j	K	M	i									DE	DE	DE	DE							FD	FD	FD	FD	FD
0.47 μF	474	Ĵ	K	M	İ									DE	DE	DE	DE		FG	EG	EG	EG	EG	FD	FD	FD	FD	FD
0.56 µF	564	J	K	M										DG	DG	DH	DH							FF	FF	FF	FF	FF
0.68 µF	684	Ĵ	K	M										DG	DG	DH	DH							FG	FG	FG	FG	FG
0.82 µF	824	J	K	M										DG	DG	DG								FL	FL	FL	FL	FL
1.0 µF	105	J	K	M										DG	DG	DG			ED	ED	ED	ED		FM	FM	FM	FM	FM
1.2 µF	125	J	K	M										İ					EH	EH	EH	EH		FG	FG	FG	FG	
1.5 µF	155	J	K	M															EH	EH	EH	EH		FG	FG	FG	FG	
1.8 µF	185	J	K	M															EF	EF	EH	EH		FG	FG	FG	FG	
2.2 µF	225	J	K	M															EF	EF	EH	EH		FG	FG	FG	FG	
2.7 µF	275	J	K	M															EH	EH	EH			FG	FG	FH	FH	
3.3 µF	335	J	K	M															EH	EH	EH			FM	FM	FM	FM	
3.9 µF	395	J	K	M															EH	EH	EH			FG	FG	FK	FK	
4.7 μF	475	J	K	M															EH	EH	EH			FG	FG	FS	FS	
5.6 µF	565	J	K	M																				FH	FH	FH		
6.8 µF	685	J	K	M																				FM	FM	FM		
8.2 μF	825	J	K	M																				FK	FK	FK		
10 μF	106	J	K	M	.	10	1/	25	/ 2	10	1/	25	F0	/ 1	10	1/	25	F0	/ .	10	1/	25	F0	FS	FS	FS	25	
		-	Voltage		6.3	10	16	25	6.3	10	16	25	50	6.3	10	16	25	50	6.3	10	16	25	50	6.3	10	16	25	50
Cap	Cap Code	<u> </u>	Itage Co		9	8	4	3	9	8	4	3	5	9	8	4	3	5	9	8	4	3	5	9	8	4	3	5
		Case	e Size/S	eries		C04	02C				0603	C				0805	С				1206	C				1210	C	



Table 2A – Chip Thickness/Tape	e & Reel Packaging Quantities



Table 2B – Bulk Packaging Quantities

Dookog	ing Tuno	Loose Pa	ackaging					
Раскау	ing Type	Bulk Bag (default)						
Packagir	ng C-Spec ¹	N/	'A ²					
Case	Size	Packaging Quantities (pieces/unit packaging)					
EIA (in)	Metric (mm)	Minimum	Maximum					
0402	1005							
0603	1608							
0805	2012		50,000					
1206	3216							
1210	3225	1						
1808	4520							
1812	4532							
1825	4564		20,000					
2220	5650							
2225	5664							

¹ The "Packaging C-Spec" is a 4 to 8 digit code which identifes the packaging type and/or product grade. When ordering, the proper code must be included in the 15th through 22nd character positions of the ordering code. See "Ordering Information" section of this document for further details. Commercial Grade product ordered without a packaging C-Spec will default to our standard "Bulk Bag" packaging. Contact KEMET if you require a bulk bag packaging option for Automotive Grade products.

² A packaging C-Spec (see note 1 above) is not required for "Bulk Bag" packaging (excluding Anti-Static Bulk Bag and Automotive Grade products). The 15th through 22nd character positions of the ordering code should be left blank. All product ordered without a packaging C-Spec will default to our standard "Bulk Bag" packaging.



Table 3A – Land Pattern Design Recommendations per IPC-7351 – Standard Termination

EIA Size Code	Metric Size Code	ı	Maxi	sity Lev mum (I rotrusio	Most))	l	Media	sity Lev an (Nor otrusio)	Density Level C: Minimum (Least) Land Protrusion (mm)					
0000	0000	С	Υ	Х	V1	V2	С	Υ	Х	V1	V2	С	Υ	Х	V1	V2	
0402	1005	0.50	0.72	0.72	2.20	1.20	0.45	0.62	0.62	1.90	1.00	0.40	0.52	0.52	1.60	0.80	
0603	1608	0.90	1.15	1.10	4.00	2.10	0.80	0.95	1.00	3.10	1.50	0.60	0.75	0.90	2.40	1.20	
0805	2012	0.99	1.44	1.66	4.47	2.71	0.89	1.24	1.56	3.57	2.11	0.79	1.04	1.46	2.42	1.81	
1206	3216	1.59	1.62	2.06	5.85	3.06	1.49	1.42	1.96	4.95	2.46	1.39	1.22	1.86	4.25	2.16	
1210	3225	1.59	1.62	3.01	5.90	4.01	1.49	1.42	2.91	4.95	3.41	1.39	1.22	2.81	4.25	3.11	

Density Level A: For low-density product applications. Recommended for wave solder applications and provides a wider process window for refow solder processes. KEMET only recommends wave soldering of EIA 0603, 0805 and 1206 case sizes.

Density Level B: For products with a moderate level of component density. Provides a robust solder attachment condition for refow solder processes. **Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC–7351).

Image below based on Density Level B for an EIA 1210 case size.

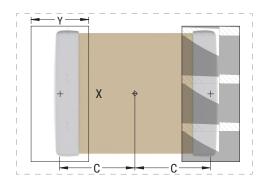




Table 3B – Land Pattern Design Recommendations per IPC-7351 – Flexible Termination

EIA Size Code	Metric Size Code	Density Level A: Maximum (Most)									



Soldering Process

Recommended Soldering Technique:

- · Solder wave or solder reflow for EIA case sizes 0603, 0805 and 1206
- · All other EIA case sizes are limited to solder reflow only

Recommended Reflow Soldering Profile:

KEMET's families of surface mount multilayer ceramic capacitors (SMD MLCCs) are compatible with wave (single or dual), convection, IR or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/ J-STD-020 standard for moisture sensitivity testing. These devices can safely withstand a maximum of three reflow passes at these conditions.

Profile Feature	Terminati	ion Finish
1 Tome readure	SnPb	100% Matte Sn
Preheat/Soak		
Temperature Minimum (T _{Smin})	100°C	150°C
Temperature Maximum (T _{Smax})	150°C	200°C
Time (t_s) from T_{smin} to T_{smax}	60 – 120 seconds	60 – 120 seconds
Ramp-Up Rate $(T_L \text{ to } T_p)$	3°C/second maximum	3°C/second maximum
Liquidous Temperature (T _L)	183°C	217°C
Time Above Liquidous (t _L)	60 – 150 seconds	60 – 150 seconds
Peak Temperature (T _P)	235°C	260°C
Time Within 5°C of Maximum Peak Temperature (t _p)	20 seconds maximum	30 seconds maximum
Ramp-Down Rate (T _P to T _L)	6°C/second maximum	6°C/second maximum
Time 25°C to Peak Temperature	6 minutes maximum	8 minutes maximum

Note 1: All temperatures refer to the center of the package, measured on the capacitor body surface that is facing up during assembly refow.

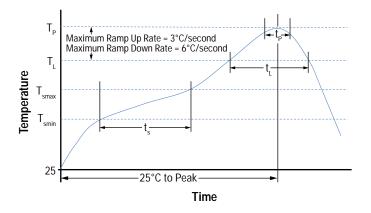


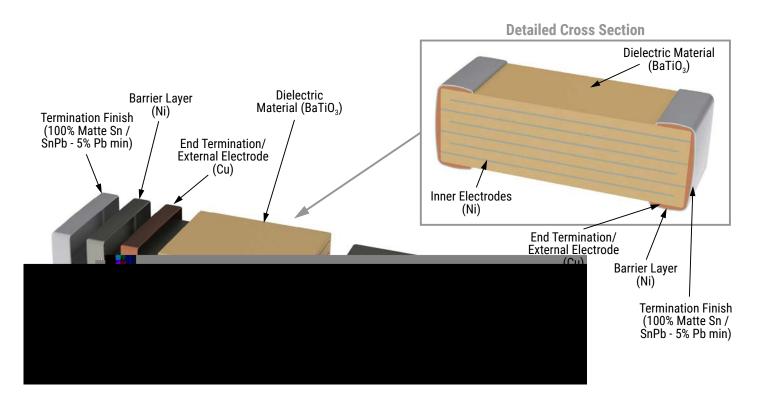


Table 4 – Performance & Reliability: Test Methods and Conditions

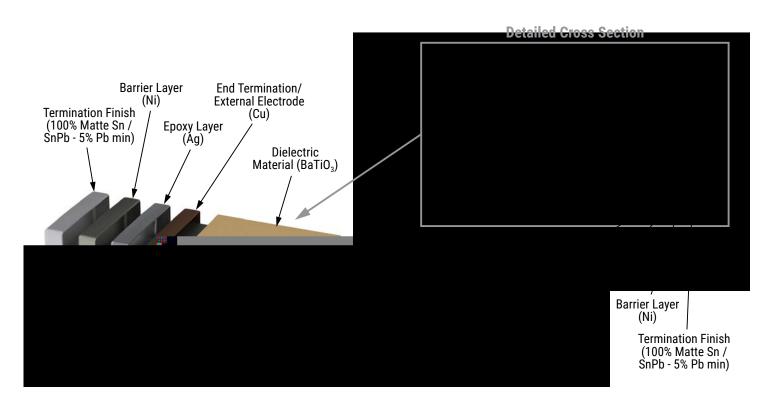
Stress	Reference	Test or Inspection Method
Terminal Strength	JIS-C-6429	Appendix 1, Note: Force of 1.8 kg for 60 seconds.
Board Flex	JIS-C-6429	Appendix 2, Note: Standard termination system – 2.0 mm (minimum) for all except 3 mm for COG. Flexible termination system – 3.0 mm (minimum).
		Magnification 50 X. Conditions:
Solderability	J-STD-002	a) Method B, 4 hours at 155°C, dry heat at 235°C
Soluerability	J-31D-002	b) Method B at 215°C category 3
		c) Method D, category 3 at 260°C
Temperature Cycling	JESD22 Method JA-104	1,000 cycles (-55°C to +150°C). Measurement at 24 hours +/- 4 hours after test conclusion.
Biased Humidity	MIL-STD-202 Method	Load Humidity: 1,000 hours 85°C/85%RH and rated voltage. Add 100K ohm resistor. Measurement at 24 hours +/- 4 hours after test conclusion. Low Volt Humidity: 1,000 hours 85°C/85% RH and 1.5 V. Add 100 K ohm resistor.
	.00	Measurement at 24 hours +/- 4 hours after test conclusion.
Moisture Resistance	MIL-STD-202 Method 106	t = 24 hours/cycle. Steps 7a and 7b not required. Measurement at 24 hours. +/- 4 hours after test conclusion.
Thermal Shock	MIL-STD-202 Method 107	–55°C/+150. Note: Number of cycles required – 300. Maximum transfer time – 20 seconds. Dwell time – 15 minutes. Air – Air.
High Temperature Life	MIL-STD-202 Method 108 /EIA-198	1,000 hours at 150°C with 2 X rated voltage applied.
Storage Life	MIL-STD-202 Method 108	



Construction – Standard Termination



Construction – Flexible Termination





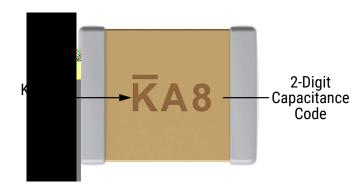
Capacitor Marking (Optional):

These surface mount multilayer ceramic capacitors are normally supplied unmarked. If required, they can be marked as an extra cost option. Marking is available on most KEMET devices but must be requested using the correct ordering code identifier(s). If this option is requested, two sides of the ceramic body will be laser marked with a "K" to identify KEMET, followed by two characters (per EIA-198 - see table below) to identify the capacitance value. EIA 0603 case size devices are limited to the "K" character only.

Laser marking option is <u>not</u> available on:

- COG, Ultra Stable X8R and Y5V dielectric devices.
- EIA 0402 case size devices.
- EIA 0603 case size devices with Flexible Termination option.
- · KPS Commercial and Automotive Grade stacked devices.
- X7R dielectric products in capacitance values outlined below.

Marking appears in legible contrast. Illustrated below is an example of an MLCC with laser marking of "KA8", which designates a KEMET device with rated capacitance of 100 µF. Orientation of marking is vendor optional.





Capacitor Marking (Optional) cont'd

Capacitance (pF) For Various Alpha/Numeral Identifiers										
Numeral										
Alpha	9	0	1	2	3	4	5	6	7	8
Character	Capacitance (pF)									
Α	0.10	1.0	10	100	1,000	10,000	100,000	1,000,000	10,000,000	100,000,000
В	0.11	1.1	11	110	1,100	11,000	110,000	1,100,000	11,000,000	110,000,000
С	0.12	1.2	12	120	1,200	12,000	120,000	1,200,000	12,000,000	120,000,000
D	0.13	1.3	13	130	1,300	13,000	130,000	1,300,000	13,000,000	130,000,000
Е	0.15	1.5	15	150	1,500	15,000	150,000	1,500,000	15,000,000	150,000,000
F	0.16	1.6	16	160	1,600	16,000	160,000	1,600,000	16,000,000	160,000,000
G	0.18	1.8	18	180	1,800	18,000	180,000	1,800,000	18,000,000	180,000,000
Н	0.20	2.0	20	200	2,000	20,000	200,000	2,000,000	20,000,000	200,000,000
J	0.22	2.2	22	220	2,200	22,000	220,000	2,200,000	22,000,000	220,000,000
K	0.24	2.4	24	240	2,400	24,000	240,000	2,400,000	24,000,000	240,000,000
L	0.27	2.7	27	270	2,700	27,000	270,000	2,700,000	27,000,000	270,000,000
М	0.30	3.0	30	300	3,000	30,000	300,000	3,000,000	30,000,000	300,000,000
N	0.33	3.3	33	330	3,300	33,000	330,000	3,300,000	33,000,000	330,000,000
Р	0.36	3.6	36	360	3,600	36,000	360,000	3,600,000	36,000,000	360,000,000
Q	0.39	3.9	39	390	3,900	39,000	390,000	3,900,000	39,000,000	390,000,000
R	0.43	4.3	43	430	4,300	43,000	430,000	4,300,000	43,000,000	430,000,000
S	0.47	4.7	47	470	4,700	47,000	470,000	4,700,000	47,000,000	470,000,000
T	0.51	5.1	51	510	5,100	51,000	510,000	5,100,000	51,000,000	510,000,000
U	0.56	5.6	56	560	5,600	56,000	560,000	5,600,000	56,000,000	560,000,000
V	0.62	6.2	62	620	6,200	62,000	620,000	6,200,000	62,000,000	620,000,000
W	0.68	6.8	68	680	6,800	68,000	680,000	6,800,000	68,000,000	680,000,000
Х	0.75	7.5	75	750	7,500	75,000	750,000	7,500,000	75,000,000	750,000,000
Υ	0.82	8.2	82	820	8,200	82,000	820,000	8,200,000	82,000,000	820,000,000
Z	0.91	9.1	91	910	9,100	91,000	910,000	9,100,000	91,000,000	910,000,000
а	0.25	2.5	25	250	2,500	25,000	250,000	2,500,000	25,000,000	250,000,000
b	0.35	3.5	35	350	3,500	35,000	350,000	3,500,000	35,000,000	350,000,000
d	0.40	4.0	40	400	4,000	40,000	400,000	4,000,000	40,000,000	400,000,000
е	0.45	4.5	45	450	4,500	45,000	450,000	4,500,000	45,000,000	450,000,000
f	0.50	5.0	50	500	5,000	50,000	500,000	5,000,000	50,000,000	500,000,000
m	0.60	6.0	60	600	6,000	60,000	600,000	6,000,000	60,000,000	600,000,000
n	0.70	7.0	70	700	7,000	70,000	700,000	7,000,000	70,000,000	700,000,000
t	0.80	8.0	80	800	8,000	80,000	800,000	8,000,000	80,000,000	800,000,000
у	0.90	9.0	90	900	9,000	90,000	900,000	9,000,000	90,000,000	900,000,000



Tape & Reel Packaging Information

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12 and 16 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.

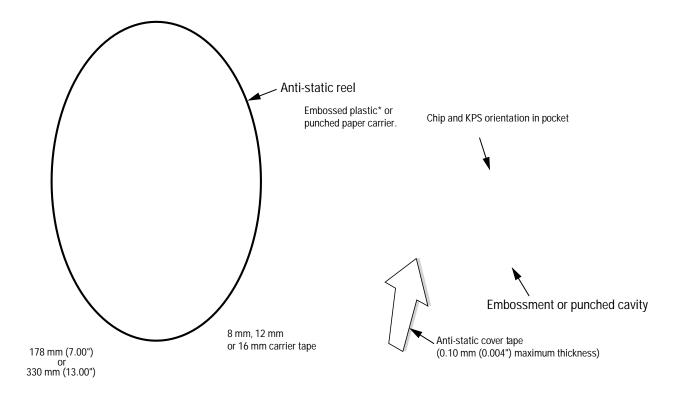




Figure 1 – Embossed (Plastic) Carrier Tape Dimensions

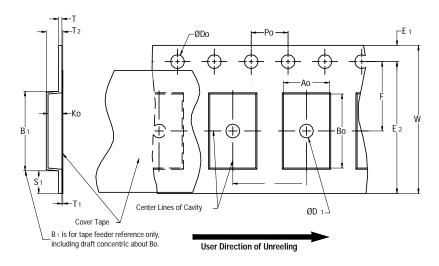




Figure 2 – Punched (Paper) Carrier Tape Dimensions

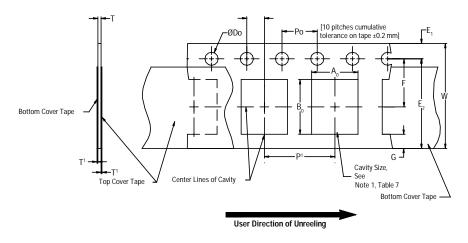


Table 7 – Punched (Paper) Carrier Tape Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)								
Tape Size	D _o	E ₁	P ₀	P ₂	T ₁ Maximum	G Minimum	R Reference Note 2	
8 mm	1.5 +0.10 -0.0 (0.059 +0.004 -0.0)	1.75 ±0.10 (0.069 ±0.004)	40					



Packaging Information Performance Notes

1. Cover Tape Break Force: 1.0 kg minimum.

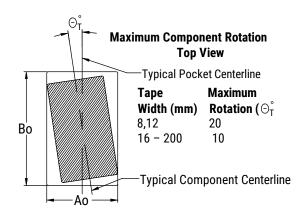
2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength				
8 mm	0.1 to 1.0 Newton (10 to 100 gf)				
12 and 16 mm	0.1 to 1.3 Newton (10 to 130 gf)				

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ± 10 mm/minute.

3. Labeling: Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. Refer to EIA Standards 556 and 624.

Figure 3 – Maximum Component Rotation



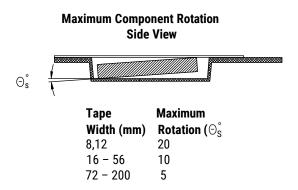


Figure 4 – Maximum Lateral Movement

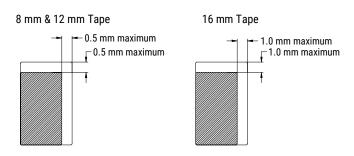


Figure 5 – Bending Radius

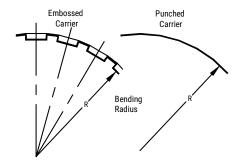
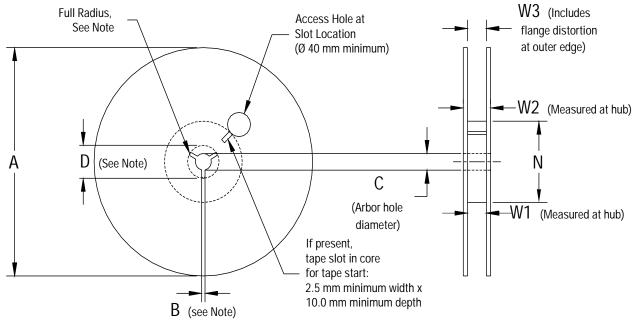




Figure 6 – Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

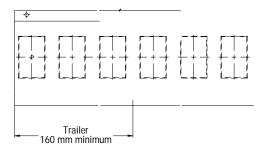
Table 8 - Reel Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)								
Tape Size	A	B Minimum	С	D Minimum				
8 mm	178 ±0.20		13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)				
12 mm	(7.008 ±0.008) or	1.5 (0.059)						
16 mm	330 ±0.20 (13.000 ±0.008)	,	(, ,	(
	Variable Dimensions — Millimeters (Inches)							
Tape Size	N Minimum	W ₁	W ₂ Maximum	W_3				
8 mm		8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)					
12 mm	50 (1.969)	12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	Shall accommodate tape width without interference				
16 mm		16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)					



Figure 7 – Tape Leader & Trailer Dimensions





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